# UC35AA (Deep UV LED)



# UVC disinfection and sterilization light

## **Features & Benefits**

- Deep ultraviolet LED
- Optimized UVC wavelength for efficacy and germicide effect
- Robust design for longer lifetime
- Lead Free

## **Applications**

• Surface, liquid and air purification



## Table of Contents

1.	Characteristics	 3
2.	Product Code Information	 5
3.	Typical Characteristics Graphs	 6
4.	Outline Drawing & Dimension	 8
5.	Reliability Test Items & Condition	 9
6.	Soldering Conditions	 10
7.	Tape & Reel	 11
8.	Label Structure	 13
9.	Packing Structure	 14
10.	Precautions in Handling & Use	 16

## 1. Characteristics

## a) Absolute Maximum Rating

ltem	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	-40 ~ +60	°C	-
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C	-
LED Junction Temperature	T <sub>j-s</sub>	90	°C	-
Forward Current	IF	150	mA	-
Assembly Process Temperature	-	260 <10	°C s	-
ESD (HBM)	-	±2	kV	-

## b) Electro-optical Characteristics (@100mA)

ltem	Symbol	Value	Unit
Peak Wavelength	λρ	275	nm
Radiant Flux	Фе	14.0	mW
Forward Voltage	Vf	5.8	V
Thermal Resistance (junction to solder point)	R <sub>th</sub>	20	K/W
Spectrum Half Width	$\Delta\lambda$	10	nm
View Angle	201/2	120	deg

#### Note:

Samsung maintains measurement tolerance of: Radiant flux =  $\pm 10\%$ , forward voltage =  $\pm 3\%$ , Peak Wavelength =  $\pm 3nm$ 

## c) Bin Structure (@100mA)

Item	BIN Code	Min	Тур	Max
	50	5.0		5.5
Forward Voltage	55	5.5		6.0
(V)	60	6.0		6.5
	65	6.5		7.0
Peak Wavelength (nm)	70	270	275	280
Radiant Flux	10	10		14
(mW)	14	14		18

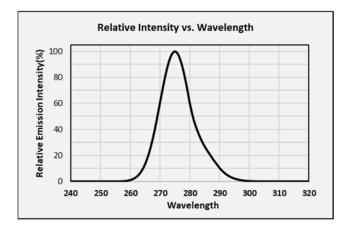
## 2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	Р	М	U	V	1	3	5	J	А	D	0	v	0	W	0	Р	0

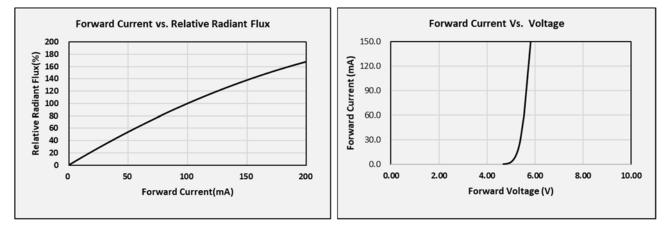
Digit	PKG Information	Code		Specificat	lion	
123	Samsung Package Middle Power	SPM				
4 5	Color	UV	Ultra Violet			
6	Product Version	1	1st version			
78	Product Size	35	3.5*3.5mm			
9	Product Thickness	J	1.75mm			
10	Sorting Current (mA)	A	100mA			
11	Peak Wavelength Range	D	270~280nm			
12	Color	0	UVC			
13 14	Forward Voltage (V)	VO	V0 : 5.0 ~ 7.0V	Bin Code	50 : 5.0 ~ 5.5V 55 : 5.5 ~ 6.0V 60 : 6.0 ~ 6.5V 65 : 6.5 ~ 7.0V	
15 16	Peak Wavelength (nm)	wo	W0 : 270 ~ 280nm	Bin Code	70 : 270 ~ 280nm	
17 18	Radiant Power (mW)	P0	P0 : 10.0 ~ 18.0 mW	Bin Code	10 : 10.0 ~ 14.0 mW 14 : 14.0 ~ 18.0 mW	

## 3. Typical Characteristics Graphs

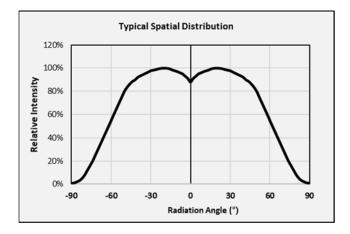
#### a) Spectrum Distribution ( $I_F = 100$ mA, Ts = 25 °C)



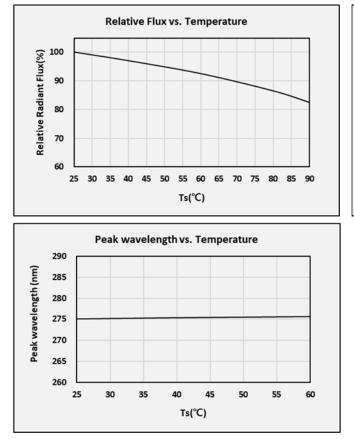
#### b) Forward Current Characteristics (Ts = 25 °C)

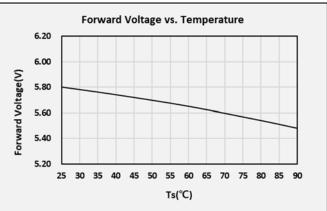


#### c) Beam Angle Characteristics (I<sub>F</sub> = 100 mA, Ts=25°C)



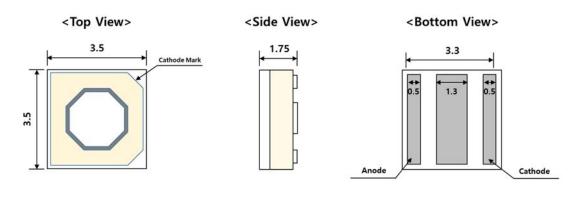
## d) Temperature Characteristics (I<sub>F</sub> = 100 mA)





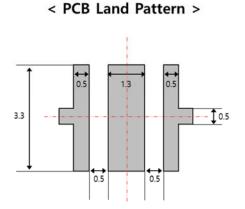
## 4. Outline Drawing & Dimension

## a) Mechanical Dimension



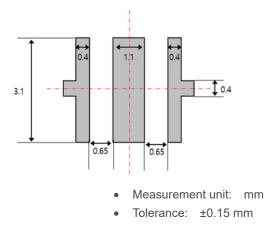
## • Tolerance: ±0.15 mm

#### b) Recommended foot-print for SMT



## < Stencil Mask Pattern >

Measurement unit: mm



#### Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2) The thermal pad is electrically isolated from the anode and cathode contact pads.
- 3) Ts point and measurement method:
  - ① Measure the nearest point to thermal pad as shown above. If necessary, remove PSR of PCB to reach Ts point.
  - ② All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

#### **Precautions:**

- Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

## 5. Reliability Test Items & Conditions

## a) Test Items

Test Item	Test Co	ndition	Test Hour / Cycle	Sample Size
Room Temperature Life Test	25⁰C, Maximum ra	ted drive current	1000 h	20
High Temperature Humidity Life Test	40°C, 90% RH, Maximu	im rated drive current	500 h	20
High Temperature Humidity On/Off Test	40°C, 90% RH , On/Off 5sec,	Maximum rated drive current	500 h	20
Temperature Cycling	-45 °C / 30 min ↔ temperature char		300 cycles	100
High Temperature Humidity Storage	40°C, 90	)% RH	500 h	20
High Temperature Storage	100	°C	500 h	2
Low Temperature Storage	-40	-40 °C		20
ESD (HBM)		R <sub>1</sub> : 10 MΩ R <sub>2</sub> : 1.5 kΩ C: 100 pF V: ±5 kV	5 times	30

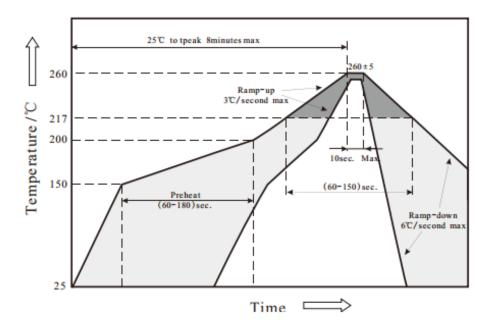
## b) Criteria for Judging the Damage

Item	Symbol	Test Condition (Ta = 25 °C)	Max or Min Allowable shift value
Forward Voltage	VF	I <sub>F</sub> = 150 mA	Max : Init. Value * 1.2
Radiant Flux	Φe	I <sub>F</sub> = 150 mA	Min : Init. Value * 0.7

## 6. Soldering Conditions

## a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



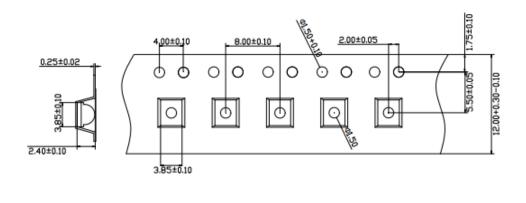
## b) Manual Soldering Conditions

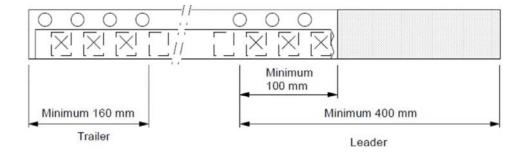
No more than 5 seconds @ max. 300 °C, under soldering iron.

## 7. Tape & Reel

## a) Taping Dimension

(unit: mm)

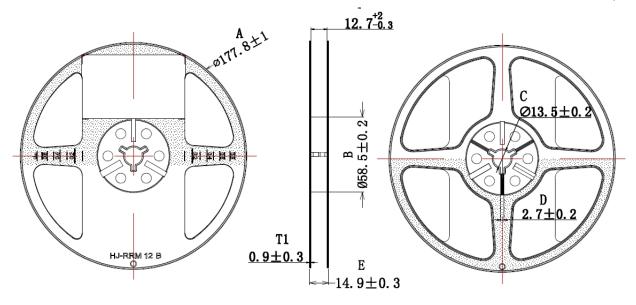




**Taping Direction** 

## b) Reel Dimension

(unit: mm)

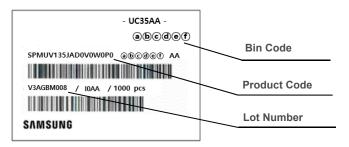


#### Notes:

- 1) Quantity: The quantity/reel is 1000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is ±0.2 mm
- 3) Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

## 8. Label Structure

#### a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

- (a)(b): Forward Voltage bin (refer to page 5)
- ©: Wavelength bin (refer to page 5)
- (e)(f): Radiant Flux bin (refer to page 5)

#### b) Lot Number

The lot number is composed of the following characters:

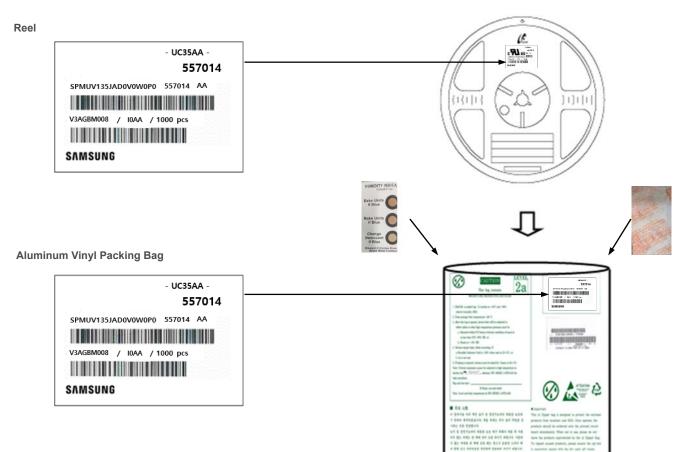


123456789 / I0(a)(b) / 1000 pcs

1,2	:	Production site (V3 : Foshan , China)
3	:	Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
4	:	Year (E: 2020, F: 2021, G : 2022,)
(5)	:	Month (1~9, A, B, C)
6	:	Day (1~9, A, B~V)
789	:	Product serial number (001 ~ 999)
(a)(b)	:	Reel number (AA, AB, AC,)

## 9. Packing Structure

## a) Packing Process



#### Outer Box

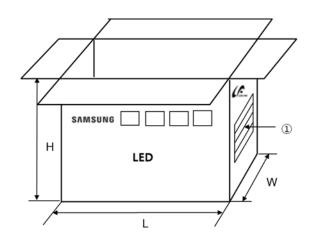
Material: Paper (SW3B(B))

Tuno		Note		
Туре	(a)	(b)	(c)	Note
7 inch S	245 ± 5	220 ± 5	86 ± 5	Up to 5 reels
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels

#### ① Side Label



Ω



#### b) Aluminum Vinyl Packing Bag



#### c) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag



## 10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
  a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
  b. Stored at <10 % RH</li>
- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at  $23 \pm 5$  °C.
- 8) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.

## **Revision History**

Date	Change History	Page	Version
2021.10.20	Creation of Document		1.0
2021.10.27	Correction of Typo		2.0
2022.11.08	Update Naming Code (UV352B $\rightarrow$ UC35AA)	1	3.0
2022.11.00	Added Naming Code to Label	13	5.0

# Legal and additional information.

#### About Samsung Electronics Co., Ltd.

Samsung Electronics Co. Ltd inspires the world and shapes the future with transformative ideas and technologies. The company is redefining the worlds of TVs, smartphones, wearable devices, tablets, digital appliances, network systems, and semiconductor and LED solutions. For the latest news, please visit the Samsung Newsroom at <a href="http://news.samsung.com">http://news.samsung.com</a>.

Copyright © 2021Samsung Electronics Co., Ltd. All rights reserved. Samsung is a registered trademark of Samsung Electronics Co., Ltd. Specifications and designs are subject to change without notice. Non-metric weights and measurements are approximate. All data were deemed correct at time of creation. Samsung is not liable for errors or omissions. All brand, product, service names and logos are trademarks and/or registered trademarks of their respective owners and are hereby recognized and acknowledged.

Samsung Electronics Co., Ltd. 1, Samsung-ro Giheung-gu Yongin-si, Gyeonggi-do, 17113 KOREA

www.samsung.com/led

## SAMSUNG